


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company	 STMicroelectronics International N.V
1.2 PCN No.	ADG/23/14262
1.3 Title of PCN	VIPOWER M0A5/M0H5: Activation of Singapore 8" Wafer Fab (SG8) as Additional Location (second wave)
1.4 Product Category	see list
1.5 Issue date	2023-08-29

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	NEMETH KRISZTINA
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Mario ASTUTI, Carmelo PISTRITTO
2.1.2 Marketing Manager	Rosario RUGGERI
2.1.3 Quality Manager	Daniela FAZIO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Wafer fabrication	ST AngMoKio 8" - SG8 (Singapore)

4. Description of change

	Old	New
4.1 Description	AngMoKio 6" - AMK6 (Singapore)	AngMoKio 6"- AMK6 (Singapore) AngMoKio 8" - SG8 (Singapore)
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	Capacity Increase
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	Dedicated Finished Good Codes
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7. Timing / schedule

7.1 Date of qualification results	2023-08-07
7.2 Intended start of delivery	2023-11-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	14262 Qualification reports.zip		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2023-08-29

9. Attachments (additional documentations)

14262 Public product.pdf
 14262 Details.pdf
 14262 Qualification reports.zip

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	VN5012AKTR-E	
	VNH5019ATR-E	

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